Design Considerations for Clamping Networks for Very High Voltage Monolithic Off-line PWM Controllers

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In the large family of Switch–Mode Power Supply (SMPS) components, the recently introduced high–voltage monolithic switchers start to play an important role. First of all because they provide an easy mean to instantaneously build an efficient off–line supply but also because their internal structure offers everything a designer needs: internal clock, pulse–by–pulse limitation, Leading Edge Blanking (LEB) etc. However, the internal MOSFET exhibits a low–energy capability body–diode which no longer protects the device against accidental avalanche. This element thus needs an adequate protection network against the electromagnetic leakage energy. This paper details what network is best adapted to the protection of these devices and how to predict its efficiency in the application.

The Leakage Inductance

Figure 1 shows a transformer wound across a standard magnetic material. The primary side made of Np turns creates the necessary force F which gives birth to two components: ϕm who links both windings, but also $\phi l1$ which does not couple to the secondary and corresponds to a leakage path through the air. Thanks to ϕm , a current lo circulates in the secondary, but this current also gives birth to another leakage flux $\phi l2$ whose polarity is opposite of that of ϕm . It is important to note that ϕm produces lo while $\phi l2$ is a consequence of it.

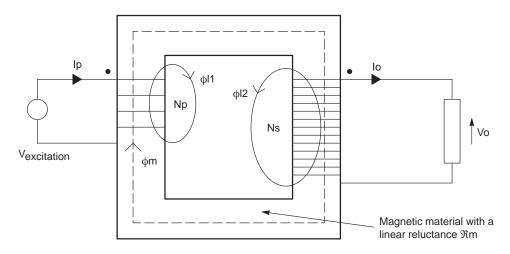
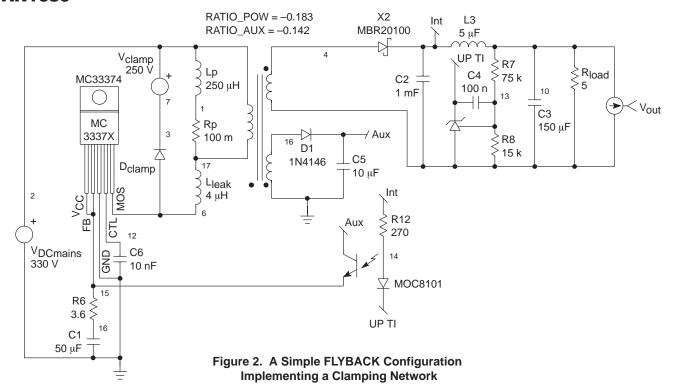


Figure 1. A Two-winding Transformer Showing the Leakage Paths



As one can see from the picture, ϕ 11 and ϕ 12 close through the air. As any (magnetic) medium, the air is affected by a Reluctance \Re , or its inverse, the permeance P. These permeances create in the primary and secondary two leakage inductance with a value of: $L_{leak} = N^2 \cdot P_{air}$, with N being the primary or secondary turns. As an effect, these parasitic leakage elements degrade the energy transfer between the primary and secondary (ies). In a FLYBACK converter, the presence of the leakage element will a) generate a voltage spike at turn–off and b) divert a portion of the primary current into the clamping network. Point a) implies the use of protection network to prevent a lethal drain voltage excursion while point b) explains the root of a degraded open–loop gain: the peak current needs to be higher than theoretically calculated to deliver the full rated output power.

The Principle of a Protection Network

The goal of the clamping network is to prevent the drain voltage to exceed a given limit. For instance, in the new MOTOROLA MC3337X family, the maximum voltage shall stay within 700 V. Worse case arises when the mains is a its highest level, e.g. 285 VAC in a universal mains application. To prevent the drain from reaching this value, **Figure 2** shows how a perfect network would work: when the MOSFET closes, the current builds—up in both primary and leakage coils. When the ON periods stops, the MOSFET opens and interrupts its current. Since no current discontinuities can take place in an inductor, both magnetic fields collapse and the voltage across the inductances reverses in an attempt to keep the amps—turn constant: Lp energy is thus coupled to the secondary and gives birth to the output current charge. Since Lleakage cannot find a circulating path, it pulls—up 2 the drain voltage until Dclamp starts to conduct and protects the switcher at a maximum theoretical level of: Vmains+Vclamp=650 V. Figure 2b shows the results of an INTUSOFT's IsSpice4 (San–Pedro, CA) simulations. When all the leakage energy is released, a short parasitic oscillation takes place involving Lleakage and all the parasitic capacitive elements present in the circuit (transformer's primary capacitance, MOSFET's Coss etc.)

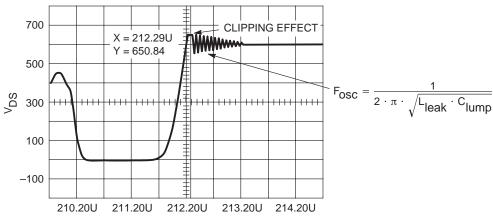


Figure 2b. The Drain is Safely Clipped Below 700 V at High Mains

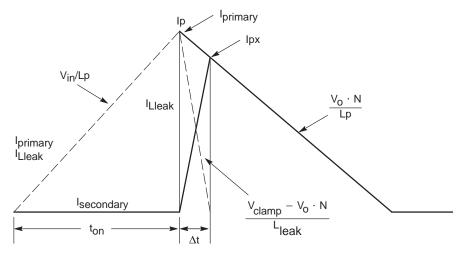


Figure 2c. Waveforms at Turn-off: the Leakage Coil Prevents an Immediate Transfer

Diverting the Primary Current

Figure 2 is interesting because it helps understanding how the reflected secondary voltage resets the leakage energy and how much of primary current this leakage inductance "steals away" by diverting it into the clamp. Everything is detailed on Figure 2c graph. When the MOSFET turns-off, a reset voltage is applied to the leakage inductance. This reset voltage depends on the clipping voltage but also on the FLYBACK's. The higher this level, the faster the leakage energy drops to zero and authorizes the secondary current to take place. The time Δt needed to complete the energy transfer is easily defined by:

$$\Delta t = \frac{L_{leak} \cdot lp}{V_{clamp} - (V_{out} + Vf_{sec}) \cdot N}, \text{ where lp is the final primary current, N the transformer ratio secondary to primary, Vf_{sec} the secondary tilde for word data, and the vertex to be a size of the secondary tilde for word data.$$

secondary diode forward drop and $L_{\mbox{\scriptsize leak}}$ the primary leakage inductance.

Estimating the percentage of diverted current tells you the real peak current you will actually put in the primary to deliver the rated power. Figure 2c's lpx point shows where the secondary diode catches—up with the primary current. The slope of the decreasing primary current is simply $\frac{N\cdot(V_{out}+Vf_{sec})}{Lp}, \text{ but this equation can also be written as: } \frac{Ip-Ipx}{\Delta t} = \frac{N\cdot(V_{out}+Vf_{sec})}{Lp}. \text{ Replacing}$

$$\frac{Lp}{Lp} = \frac{L}{Lp} = \frac{L}{Lp}$$

current stolen by the leakage inductance. Applying Figure 2 numerical values gives: lpx = 98.4% of lp. Since lp grows up to 2.73 A, then the theoretical peak secondary current establishes at: $0.984 \cdot 2.73 \cdot 12.5 = 33.58$ A. **Figure 2d** validates the calculation.

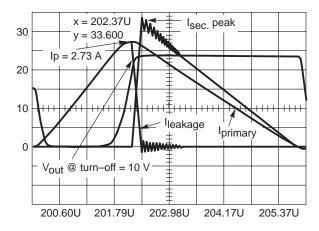


Figure 2d. IsSpice4 Simulation of Figure 2's Circuit

Protecting the MOSFET with an Active Element

The easiest way to clamp at a known level is to replace the null–impedance V_{clamp} source by a zener diode or a transient suppressor. **Figures 4** and **4b** detail the connections and their associated waveforms. Since we have two diodes in series, we have

to care about both dissipated powers. Diodes can be modeled by a voltage source V (which equals V_{zener} or $V_{forward}$) in series with a dynamic resistance Rd. The total average *conducted* power dissipated is therefore: $P_{avg} = V \cdot I_{avg} + R_d \cdot I^2$ rms. For the zener diode, the first part is easily deducted from Figure 3b: $P_{avg} = \frac{V_z \cdot Ip}{2} \cdot \frac{\Delta t}{T}$ or, once solving with Δt :

 $P_{avg1} = \frac{V_Z \cdot Ip^2 \cdot L_{leak} \cdot F}{2 \cdot (V_Z - (V_{out} + Vf_{sec}) \cdot N)}, \text{ with F the switching frequency and } V_Z \text{ the nominal zener level.}$

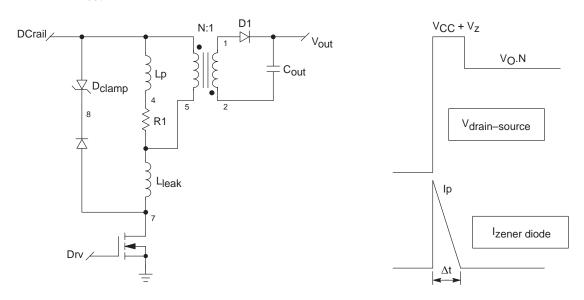


Figure 3. Clipping with a Zener is Possible Solution

Figure 3b. Clipping Waveforms with a Zener Diode

To account for the Rd term, MOTOROLA specifies a clamping factor F_C which gives the real peak zener voltage at a given peak current: $V_{Z(Peak)} = V_{Z(Nom)}$. Fc. From this formula, we can write: $V_{Z(Nom)} + Rd \cdot I_{Z(Peak)} = Fc \cdot V_{Z(Nom)}$. Solving for Rd gives:

$$Rd = \frac{(Fc - 1) \cdot V_{z(Nom)}^{2}}{P_{PK(Nom)}}, with P_{PK(Nom)} being the maximum peak power accepted by the zener diode or the transient suppression.$$

sor. From Figure 3b, let's now calculate the RMS and average values of the zener current: $I_{zener}(t) = Ip \cdot \frac{\Delta t - t}{\Delta t}$, to obtain the

RMS value simply solve:
$$\sqrt{\frac{1}{T}}\int\limits_{0}^{\Delta t}I^{2}zener(t).dt \text{ or } I_{zener}RMS=Ip\cdot\sqrt{\frac{\Delta t}{3\cdot T}}, \text{ T is the switching period. P}_{avg}2 \text{ is thus: } I_{zener}RMS=Ip\cdot\sqrt{\frac{\Delta t}{3\cdot T}}$$

$$P_{avg}^2 = \frac{Rd \cdot Ip^2 \cdot F \cdot \Delta t}{3}$$

The $I_{zener}AVG$ value, which affects the conduction losses of the diode in series with the zener is evaluated by: $I_{zener}AVG = \frac{Ip \cdot \Delta t \cdot F}{2}$. As we previously wrote, the diode conduction losses are expressed the same way as the zener's, except

that $Rd = \frac{dVf}{dId}$ extracted from the Vf versus Id curve in the diode data—sheet at Id = Ip. To summarize we have:

$$P_{cond_zener} = \frac{Ip^2 \cdot L_{leak} \cdot F \cdot (V_z + 0.66 \cdot Rd \cdot Ip)}{2 \cdot (V_z - N \cdot (V_{out} + Vf_{sec}))}$$

$$P_{cond_diode} = \frac{Ip^2 \cdot L_{leak} \cdot F \cdot (V_f + 0.66 \cdot Rd_{lp} \cdot Ip)}{2 \cdot (V_z - N \cdot (V_{out} + Vf_{sec}))}$$
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The final clipping level will be affected by two components: the zener clamping factor F_C but also the time the series diode takes to react. If we select a fast MOTOROLA MUR160, the data—sheet specifies a turn—on time of 50 ns. In presence of drain voltage rising with a 1.5 kV/ μ s slope, the diode will start to conduct at $V_{mainSDC} + Vz \cdot F_C$. If we take the highest mains level of 275VAC and a 180 V zener diode, then the series diode starts to clip at 605 V. However, because the injection time into the low—doped N-region takes about 50 ns, the dynamic resistance of the MUR160 gradually drops to its nominal value, accordingly generating an overshoot upon the drain. Measurements have to be carried upon the final board to confirm the safety of the final drain level.

When to Use a Zener or a Transient Suppressor?

There are little technology differences behind a standard zener diode and a transient. However, the die area is far bigger for a transient suppressor than that of zener. A 5 W zener diode like the 1N5388B will accept 180 W peak power if it lasts less than

8.3 ms. If the peak current in the worse case (e.g. when the PWM circuit maximum current limit works) multiplied by the nominal zener voltage exceeds these 180 W, then the diode will be destroyed when the supply experiences overloads. A transient suppressor like the P6KE200 still dissipates 5 W of continuous power but is able to accept surges up to 600 W @ 1 ms. If the peak power is really high, then turn to a 1.5KE200 which accepts up to 1.5 kW @ 1 ms.

A Passive RC Network to Clamp the Drain

If the above solution provides a stable clamping level rather independent from peak current variations, the cost of those zener elements can degrade the overall price of your SMPS. The alternative lies in implementing a passive RC network as the one depicted in **Figure 4**.

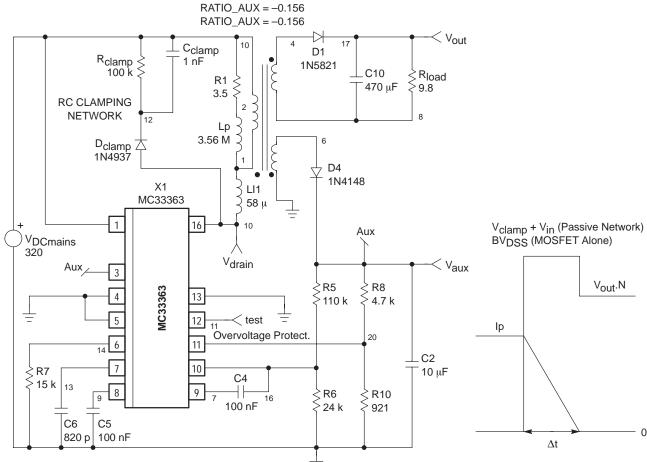


Figure 4. An RC Network Clamps the Drain Voltage at Turn-off

Figure 4b. Turn-off Waveforms with a MOSFET Clipping the Peak

If we assume we do not have any external clipping network, we can calculate the amount of energy E_T dissipated in the transistor every time it opens, assuming it would safely avalanche the voltage (**Figure 4b**). As we said, the leakage tries to keep the current circulating at its level (Ip, when the transistor opens) during Δt and pushes the drain voltage up to BVDSS. Ip(t) can be expressed by: $Ip(t) = Ip \cdot \frac{\Delta t - t}{\Delta t}$. You calculate the energy by integrating over time the cross—over area between current and voltage:

$$\mathsf{E}_{\mathsf{T}} = \int\limits_{0}^{\Delta t} \mathsf{Id}(t) \cdot \mathsf{V}_{\mathsf{DS}(t)} \cdot \mathsf{d}t = \frac{1}{2} \cdot \mathsf{Ip} \cdot \mathsf{BV}_{\mathsf{DSS}} \cdot \Delta t \cdot \mathsf{If} \text{ we now introduce the term } \Delta t \text{ previously calculated, we get:}$$

$$P_T = \frac{1}{2} \cdot Ip^2 \cdot L_{leak} \cdot F \cdot \frac{BV_{DSS}}{BV_{DSS} - (V_{out} + Vf_{sec}) \cdot N}. \\ This results depicts the average power the transistor would be the seat of if no mean were implemented to re–route the energy spike elsewhere.$$

By wiring a RC network from drain to VDCmains via a fast diode we will prevent the drain voltage to rise above VDCmains + Vclamp, the clipping voltage we want to impose (Figure 4b). Let us first consider that the voltage across the RC network is constant (ripple is low compared to average voltage) and equals V_{clamp}. The average power dissipated at turn-off in the clamp is: $P_{clamp} = \frac{1}{2} \cdot V_{clamp} \cdot Ip \cdot \Delta t \cdot F. \Delta t \text{ has already been defined, but this time, BVDSS is replaced by } V_{clamp}. Once introduced in the state of the state$ the previous equation, we obtain the power dissipated in the clipping network:

$$P_{clamp} = \frac{1}{2} \cdot Ip^{2} \cdot L_{leak} \cdot F \cdot \frac{V_{clamp}}{V_{clamp} - (V_{out} + Vf_{sec}) \cdot N}$$

Since this power will mainly be dissipated by the resistor R_{Clamp} at steady-state, we can write the following equality:

$$\frac{V_{clamp}^2}{R_{clamp}} = \frac{1}{2} \cdot Ip^2 \cdot L_{leak} \cdot F \cdot \frac{V_{clamp}}{V_{clamp} - (V_{out} + Vf_{sec}) \cdot N}.$$
 By solving for R_{clamp} we calculate its value for a given level of clamping voltage:

$$R_{clamp} = \frac{2 \cdot V_{clamp} \cdot (V_{clamp} - (V_{out} + Vf_{sec}) \cdot N)}{L_{leak} \cdot lp^2 \cdot F}$$

It is important to minimize the ripple level Vripple superimposed on V_{clamp} . A capacitor C_{clamp} will fulfill this function. If we agree that the amount of charge Q will equally split between R_{clamp} and C_{clamp} at turn-off we can write: V_{ripple} . $C_{clamp} = I_{Rclamp}$. T. Knowing that I_{Rclamp} = V_{clamp} / R_{clamp} and then solving for C_{clamp} it comes:

$$C_{clamp} = \frac{V_{clamp}}{V_{ripple} \cdot F \cdot R_{clamp}}$$

In steady-state operation, by neglecting the RMS current circulating in R_{clamp}, the RMS current which flows in the capacitor is the same as in the fast series diode:

$$I_{RMS}C_{clamp} = Ip \cdot \sqrt{\frac{\Delta t}{3 \cdot T}}$$

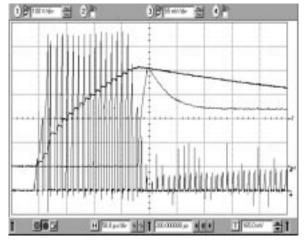
 $I_{RMS}C_{clamp} = Ip \cdot \sqrt{\frac{\Delta t}{3 \cdot T}}$ It is also sometimes interesting to know the clamp voltage set by known RC elements. In that case, simply apply:

$$V_{clamp} = \frac{1}{2} \cdot V_{out} \cdot N + \frac{1}{2} \cdot \sqrt{V_{out}^2 \cdot N^2 + 2 \cdot R_{clamp} \cdot L_{leak} \cdot Ip^2 \cdot F}$$

Watch-out for the Current Dependency!

If RC networks are more attractive than zeners when talking about price, they suffer from a poor behavior when the peak current varies. As a matter of fact, the clamping level will always be calculated at the highest primary current. The highest primary current depends, of course, on the internal current limit (at the highest T_J) but also from the turn-off response time due to the over-current comparator propagation delay. For the MC3337X family, this value is typically 280 ns, while the maximum current limit increases by roughly 3.5% at the maximum operating temperature. As an example, let us take a primary inductance of 290 μH. With this value in mind, a high mains of 285 VAC imposes a slope of 1.38 A/µs when the MOSFET closes. The maximum current limit of the MC33374 is set at 3.7 + 3.5% = 3.83 A. With the previous slope and a total delay of 280 ns, the switch will close when the current finally reaches: $3.83 \text{ A} + 0.28 \,\mu\text{s} \cdot 1.38 = 4.21 \,\text{A}$.

To have an idea of the peak current dependency of the RC network's clamp level, we built a 13 W power supply supposed to operate on wide mains. Despite a 400 mA nominal peak current, we used an MC33373 to operate without an heatsink. MC33373 authorizes peak currents up to 3 A. The RC network was specified to clamp at 240 V @ Ip nominal and gave values of 11 kΩ and 100 nF. With a 118 μ H leakage inductance and a 13.8 turn ratio, the normal operating clamping voltage was measured at 238 V.



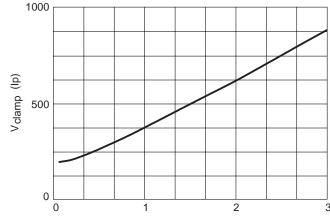


Figure 5. Turn-on Sequence Showing Vclamp Running Away to Large Values

Figure 5b. This Plot Shows How V_{clamp} Moves with Ip

However, as one can see from **Figure 5**, the clamping level grows—up by adding successive voltage steps, corresponding to every switch turn—off. At power—on, V_{clamp} and V_{out} are both at zero. The internal error amplifier pushes the duty—cycle toward 70% but each cycle is fortunately truncated when I_{drain} exceeds the internal limitation. V_{clamp} starts to grow and keeps rising until V_{out} nominal is reached and forces the PWM modulator to brake: V_{clamp} then diminishes to establish at the calculated 240 V. If for some reasons maximum I_{peak} conditions would stay longer than expected (e.g. V_{out} could not reach it nominal value), V_{clamp} would continue its grow, no longer protecting the internal MOSFET. To avoid this condition, **Figure 5b**'s plot depicting $V_{clamp} = f(Ip)$ will help the designer to track worse case conditions and react by either lowering R_{clamp} or simply selecting a member of the MC3337X family exhibiting a maximum peak current of 400–500 mA (e.g. MC33369). Another solution is to use an adequate zener diode whose clamping level will be less sensitive to peak current variations.

Selecting the Right Active Components

The series diode should be fast enough to clamp as soon as the drain voltage exceeds $V_{clamp} + V_{DCrail}$. As you can understand, the switching time should be selected accordingly with the drain voltage rising slope, dV_{DS} / dt. To illustrate this point, **Figure 6** shows a little spike superimposed upon the drain voltage at turn—off due to this diode turn—on time. This shot is directly taken from Figure 4 circuit. Once again, this spike should never exceeds BV_{DSS} .

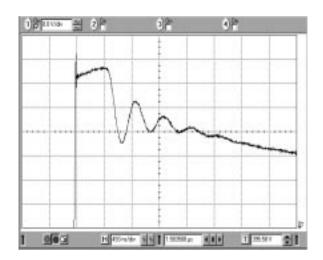


Figure 6. The Diode Turn-on Time Allows VDS to Continue its Rise Before it Actually Clamps

The zener clamping level must be selected to be between 40 to 80 volts above the reflected output voltage when the supply is heavily loaded. The given formulae will help you determining the average losses of the zener but also its maximum peak power (e.g. during power—on). The following MOTOROLA references can be used as active clipping elements:

Reference	Nominal Voltage (V)	Average Power (W)	Maximum Peak Power
1N5953B	150	1.5	98 W @ 1 ms
1N5955B	180	1.5	98 W @ 1 ms
1N5383B	150	5	180 W @ 8.3 ms
1N5386B	180	5	180 W @ 8.3 ms
1N5388B	200	5	180 W @ 8.3 ms
P6KE150A	150	5	600 W @ 1 ms
P6KE180A	180	5	600 W @ 1 ms
P6KE200A	200	5	600 W @ 1 ms
1.5KE150A	150	5	1.5 kW @ 1 ms
1.5KE180A	180	5	1.5 kW @ 1 ms
1.5KE200A	200	5	1.5 kW @ 1 ms

X = Full Scale Span

Another benefit of using a zener diode is to limit the inverse voltage applied upon the fast series diode during turn—on at $V_{RRM} = V_{DCmains}$. In the presence of an RC clamping network, the clamping level unfortunately adds to the input voltage and forces the adoption of a diode with better V_{RRM} parameter: $V_{RRM} = V_{DCmains} + V_{Clamp}$.

Depending on the dVDS/dt slope and maximum reverse voltage conditions, the following MOTOROLA references can be used:

Reference	v_{RRM}	T _{on} (typical)	I _F max
MUR160	600 V	50 ns	3 A
MUR100E	1000 V	25 ns	3 A
1N4937	600 V	200 ns	1 A
MSR860*	600 V	100 ns	8 A
MSRB860-1*	600 V	100 ns	8 A

^{*} soft recovery diodes

Parameter Evolutions with Temperature

Once protected, the equipment must survive in its operating environment. That is to say, despite the component's key specs (e.g. T_{fr} for the series diode) variations with the ambient temperature, they must not jeopardize the SMPS operation. The below lines give an idea on the way these parameters move with temperature:

MC3337X's MOSFET BVDSS: positive temperature coefficient MC3337X's maximum current limit: +1.03% at T_J = 125°C MC3337X's oscillator frequency: 115 kHz at max T_J Zener breakdown voltage: positive temperature coefficient Diode reverse recovery time: positive temperature coefficient

Conclusion

In FLYBACK converters, leakage inductance always stresses the switching elements. An efficient active or passive protection network is therefore mandatory to ensure the SMPS will survive in any operating conditions. This paper details some possibilities on how to implement the adequate level of protection.

Data-sheets can be downloaded at: http://mot-sps.com/books/current.html Spice models of diodes and MC3337X: http://mot-sps.com/models/html/models.html

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